

# "Half-Bridge" IGBT INT-A-PAK, (Standard Speed IGBT), 100 A

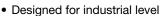


**INT-A-PAK** 

PRODUCT SUMMARY				
V <sub>CES</sub>	600 V			
I <sub>C</sub> DC	220 A			
V <sub>CE(on)</sub> at 100 A, 25 °C	1.11 V			
Speed	DC to 1 kHz			
Package	INT-A-PAK			
Circuit	Half bridge			

#### **FEATURES**

- Standard speed PT IGBT technology
- · Optimized for hard switching speed
- FRED Pt® antiparallel diodes with fast recovery
- Very low conduction losses
- Al<sub>2</sub>O<sub>3</sub> DBC
- UL approved file E78996



 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **BENEFITS**

- Optimized for high current inverter stages (AC TIG welding machines)
- Direct mounting to heatsink
- Very low junction to case thermal resistance
- Low EMI

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter voltage	V <sub>CES</sub>		600	V
Continuous collector current	I <sub>C</sub>	T <sub>C</sub> = 25 °C	220	
		T <sub>C</sub> = 130 °C	100	Α
Pulsed collector current	I <sub>CM</sub>		440	A
Peak switching current	I <sub>LM</sub>		440	
Gate to emitter voltage	$V_{GE}$		± 20	V
RMS isolation voltage	V <sub>ISOL</sub>	Any terminal to case, t = 1 min	2500	V
Maximum power dissipation	P <sub>D</sub>	T <sub>C</sub> = 25 °C	780	W
		T <sub>C</sub> = 100 °C	312	VV
Operating junction temperature range	TJ		-40 to +150	°C
Storage temperature range	T <sub>Stg</sub>		-40 to +125	C

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V <sub>BR(CES)</sub>	$V_{GE} = 0 \text{ V}, I_{C} = 1 \text{ mA}$		-	-		
		V <sub>GE</sub> = 15 V, I <sub>C</sub> = 100 A	-	1.11	1.28	1	
Collector to emitter voltage	V <sub>CE(on)</sub>	I <sub>C</sub> = 200 A	-	1.39	-	V	
		V <sub>GE</sub> = 15 V, I <sub>C</sub> = 100 A, T <sub>J</sub> = 125 °C	-	1.08	1.22		
Gate threshold voltage	$V_{GE(th)}$	I <sub>C</sub> = 0.25 mA	3	-	6		
Collector to emitter leakage current	I <sub>CES</sub>	$V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}$	-	-	1	mA	
		V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 600 V, T <sub>J</sub> = 125 °C	-	-	10		
Diode forward voltage drop	$V_{FM}$	I <sub>C</sub> = 100 A, V <sub>GE</sub> = 0 V	-	1.44	1.96	V	
		$I_C = 100 \text{ A}, V_{GE} = 0 \text{ V}, T_J = 125 ^{\circ}\text{C}$	-	1.25	1.54	V	
Gate to emitter leakage current	I <sub>GES</sub>	V <sub>GE</sub> = ± 20 V	-	-	± 250	nA	

Revision: 10-Jun-15 1 Document Number: 94544





<b>SWITCHING CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Total gate charge	Qg	I <sub>C</sub> = 100 A	-	640	700	
Gate to emitter charge	Q <sub>ge</sub>	V <sub>CC</sub> = 400 V	-	108	120	nC
Gate to collector charge	Q <sub>gc</sub>	V <sub>GE</sub> = 15 V	-	230	300	
Rise time	t <sub>r</sub>	1 100 4	-	0.45	-	
Fall time	t <sub>f</sub>	$I_C = 100 \text{ A}$ $V_{CC} = 480 \text{ V}$	-	1.0	-	μs
Turn-on switching energy	E <sub>on</sub>	V <sub>GE</sub> = 15 V	-	4	6	
Turn-off switching energy	E <sub>off</sub>	$R_g = 15 \Omega$ $T_{.1} = 25 ^{\circ}C$	-	23	29	
Total switching energy	E <sub>ts</sub>	1 1j = 25 C	-	27	35	
Turn-on switching energy	E <sub>on</sub>	I <sub>C</sub> = 100 A, V <sub>CC</sub> = 480 V	-	6	12	mJ
Turn-off switching energy	E <sub>off</sub>	$V_{GE} = 15 \text{ V}, R_g = 15 \Omega$	-	35	40	
Total switching energy	E <sub>ts</sub>	T <sub>J</sub> = 125 °C	-	41	52	
Input capacitance	C <sub>ies</sub>	V <sub>GF</sub> = 0 V	-	16 250	-	
Output capacitance	C <sub>oes</sub>	V <sub>CC</sub> = 30 V	-	1040	-	pF
Reverse transfer capacitance	C <sub>res</sub>	f = 1.0 MHz	-	190	-	
Diode reverse recovery time	t <sub>rr</sub>	I <sub>E</sub> = 50 A	-	91	155	ns
Diode peak reverse current	I <sub>rr</sub>	dl <sub>F</sub> /dt = 200 A/μs	-	10.6	15	Α
Diode recovery charge	Q <sub>rr</sub>	$V_{rr} = 200 \text{ V}$	-	500	900	nC
Diode reverse recovery time	t <sub>rr</sub>	I <sub>E</sub> = 50 A	-	180	344	ns
Diode peak reverse current	I <sub>rr</sub>	dl <sub>F</sub> /dt = 200 A/μs	-	17	20.5	Α
Diode recovery charge	Q <sub>rr</sub>	V <sub>rr</sub> = 200 V, T <sub>J</sub> = 125 °C	-	1633	2315	nC

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS
Operating junction temperature range		TJ	-40	-	150	°C
Storage temperature range		T <sub>Stg</sub>	-40	-	125	
Junction to case	per switch	R <sub>thJC</sub>	-	-	0.16	°C/W
	per diode		-	-	0.48	
Case to sink per module		R <sub>thCS</sub>	-	0.1	-	
Mounting torque	case to heatsink		-	-	4	Nm
	case to terminal 1, 2, 3		-	-	3	
Weight			-	185	-	g



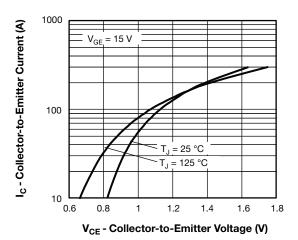


Fig. 1 - Typical Output Characteristics

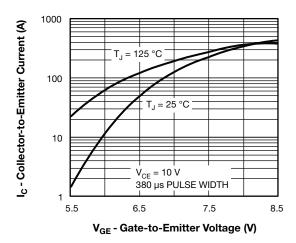


Fig. 2 - Typical Transfer Characteristics

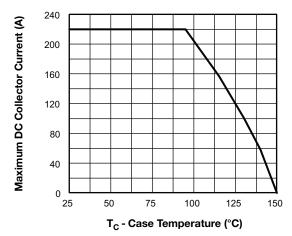


Fig. 3 - Maximum Collector Current vs. Case Temperature

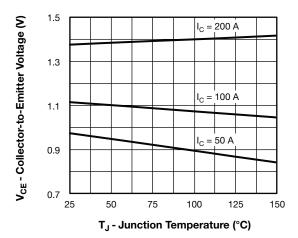


Fig. 4 - Typical Collector to Emitter Voltage vs. Junction Temperature

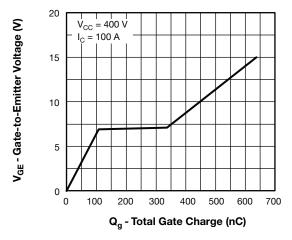


Fig. 5 - Typical Gate Charge vs. Gate to Emitter Voltage

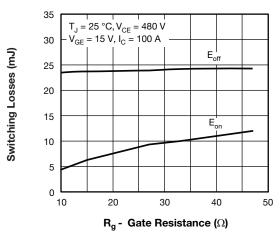


Fig. 6 - Typical Switching Losses vs. Gate Resistance

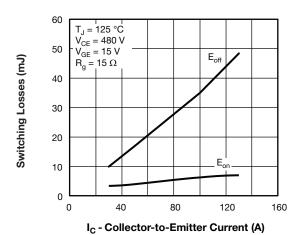


Fig. 7 - Typical Switching Losses vs. Collector to Emitter Current

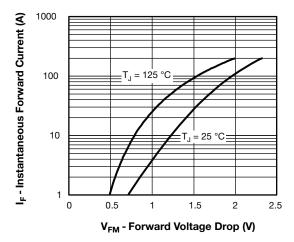


Fig. 8 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

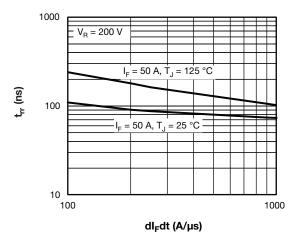


Fig. 9 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

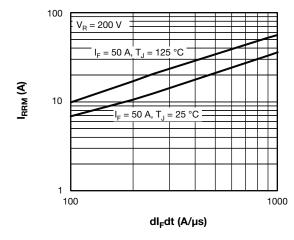


Fig. 10 - Typical Reverse Recovery Current vs. dl<sub>F</sub>/dt

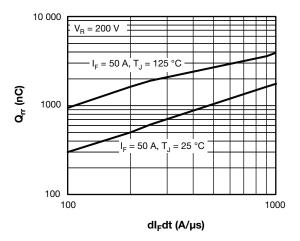
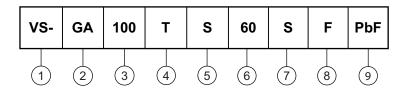


Fig. 11 - Typical Stored Charge vs. dl<sub>F</sub>/dt



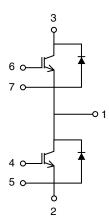
#### **ORDERING INFORMATION TABLE**

#### **Device code**



- 1 Vishay Semiconductors product
- 2 Essential part number IGBT modules
- 3 Current rating (100 = 100 A)
- Circuit configuration (T = Half bridge)
- 5 INT-A-PAK
  - Voltage code (60 = 600 V)
- 7 Speed/type (S = Standard speed IGBT)
- 8 Diode type
- 9 None = Standard production; PbF = Lead (Pb)-free

#### **CIRCUIT CONFIGURATION**

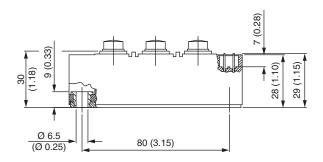


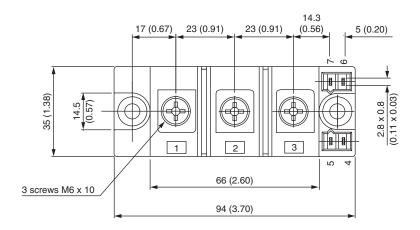
LINKS TO RELATED DOCUMENTS			
Dimensions	www.vishay.com/doc?95173		

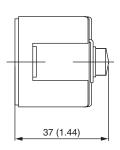


## **INT-A-PAK IGBT**

### **DIMENSIONS** in millimeters (inches)









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